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## **BIB DATA SHEET**

## **CONFIRMATION NO. 5291**

APPLICANTS Sadami Takeoka, Osaka, JAPAN; Mitsuyasu Ohta, Osaka, JAPAN; Osamu Ichikawa, Osaka, JAPAN; Masayoshi Yoshimura, Kyoto, JAPAN;  *** CONTINUING DATA **********************************	NO. 88-820 EPENDENT CLAIMS	
APPLICANTS Sadami Takeoka, Osaka, JAPAN; Mitsuyasu Ohta, Osaka, JAPAN; Osamu Ichikawa, Osaka, JAPAN; Masayoshi Yoshimura, Kyoto, JAPAN;  *** CONTINUING DATA **********************************		
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This application is a DIV of 10/187,269 07/02/2002 PAT 6,734,549  *** FOREIGN APPLICATIONS ************************************		
** FOREIGN APPLICATIONS ************************************		
O6/29/2004  Foreign Priority claimed		
35 USC 119(a-d) conditions met  verified and  verified and		
McDermott, Will & Emery 600 13th Street, N.W. Washington, DC 20005-3096 UNITED STATES	. 4	
600 13th Street, N.W. Washington, DC 20005-3096 UNITED STATES		
TITLE		
Semiconductor wiring substrate, semiconductor device, method for testing semiconductor device method for mounting semiconductor device	e, and	
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